HVL385C
Variable Capacitance Diode for VCO
REJ03G0225－0200
Rev．2．00
Mar 03， 2006

## Features

－High capacitance ratio．$(\mathrm{n}=2.43 \mathrm{~min})$
－Low series resistance．（rs $=0.75 \Omega$ max）
－Extremely small Flat Lead Package（EFP）is suitable for surface mount design．

## Ordering Information

| Type No． | Laser Mark | Package Name | Package Code |
| :---: | :---: | :---: | :---: |
| HVL385C | T | EFP | PXSF0002ZA－A |

## Pin Arrangement



1．Cathode
2．Anode

## Absolute Maximum Ratings

| Item | Symbol | Value | Unit |
| :--- | :--- | :---: | :---: |
| $\mathrm{C})$ |  |  |  |
| Reverse voltage | $\mathrm{V}_{\mathrm{R}}$ | 15 | V |
| Junction temperature | Tj | 125 | ${ }^{\circ} \mathrm{C}$ |
| Storage temperature | Tstg | $-55 \mathrm{to}+125$ | ${ }^{\circ} \mathrm{C}$ |

## Electrical Characteristics

$\left(\mathrm{Ta}=25^{\circ} \mathrm{C}\right)$

| Item | Symbol | Min | Typ | Max | Unit | Test Condition |
| :--- | :--- | :---: | :---: | :---: | :---: | :--- |
| Reverse current | $\mathrm{I}_{\mathrm{R} 1}$ | - | - | 10 | nA | $\mathrm{V}_{\mathrm{R}}=10 \mathrm{~V}$ |
|  | $\mathrm{I}_{\mathrm{R} 2}$ | - | - | 100 |  | $\mathrm{~V}_{\mathrm{R}}=10 \mathrm{~V}, \mathrm{Ta}=60^{\circ} \mathrm{C}$ |
| Capacitance | $\mathrm{C}_{0.5}$ | 7.30 | - | 7.70 | pF | $\mathrm{V}_{\mathrm{R}}=0.5 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ |
|  | $\mathrm{C}_{2.5}$ | 2.90 | - | 3.18 |  | $\mathrm{~V}_{\mathrm{R}}=2.5 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ |
| Capacitance ratio | n | 2.43 | - | 2.57 | - | $\mathrm{C}_{0.5} / \mathrm{C}_{2.5}$ |
| Series resistance | $\mathrm{r}_{\mathrm{S}}$ | - | - | 0.75 | $\Omega$ | $\mathrm{~V}_{\mathrm{R}}=1 \mathrm{~V}, \mathrm{f}=470 \mathrm{MHz}$ |

Note: For EFP package, the material of lead is exposed for cutting plane. There for, soldering nature of lead tip part is considered as unquestioned. Please kindly consider soldering nature.

Main Characteristic


Fig. 1 Reverse current vs. Reverse voltage


Fig. 3 Series resistance vs. Reverse voltage

## Package Dimensions



RenesasTechnology Corp. Sales Strategic Planning Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan
Keep safety first in your circuit designs! maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage
Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of nonflammable material or (iii) prevention against any malfunction or mishap.

Notes regarding these materials
These materials are intended as a reference to assist our customers in the selection of the Renesas Technology Corp. product best suited to the customer's application; they do not convey any license under any intellectual property rights, or any other rights, belonging to Renesas Technology Corp. or a third party . Renesas Technology Corp. assumes no responsibility for any damage, or infringement of any third-party's rights, originating in the use of any product data
3. All information contained in these materials, including product data, diagrams, charts, programs and algorithms represents information on products at the time of publication of these materials, and are subject to change by Renesas Technology Corp. without notice due to product improvements or other reasons. It is therefore recommended that customers contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor for the latest product information before purchasing a product listed herein
The information described here may contain technical inaccuracies or typographical errors
Renesas Technology Corp. assumes no responsibility for any damage, liability, or other loss rising from these inaccuracies or errors.
Please also pay attention to information published by Renesas Technology Corp. by various means, including the Renesas Technology Corp. Semiconductor
4. When using any or all of the information
evaluate all information of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to no responsibility for any damage, liability before making a final decision on the applicability of the information and products. Renesas Technology Corp. assumes
5. Renesas Technology Corp. semiconductors are not designed or manufactured for use in a device or system that is used under circumstances in which human life is potentially at stake. Please contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor when considering the use of a product contained herein for any specific purposes, such as apparatus or systems for transportation, vehicular, medical, aerospace, nuclear, or undersea repeate use.
6. The prior written approval of Renesas Technology Corp. is necessary to reprint or reproduce in whole or in part these materials.
7. If these products or technologies are subject to the Japanese export control restrictions, they must be exported under a license from the Japanese government and cannot be imported into a country other than the approved destination.
Any diversion or reexport contrary to the export control laws and regulations of Japan and/or the country of destination is prohibited.
8. Please contact Renesas Technology Corp. for further details on these materials or the products contained therein.


Refer to "http://www.renesas.com/en/network" for the latest and detailed information.

## Renesas Technology America, Inc. <br> 450 Holger Way, San Jose, CA 95134-1368, U.S.A <br> Tel: <1> (408) 382-7500, Fax: <1> (408) 382-7501

Renesas Technology Europe Limited
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K.
Tel: <44> (1628) 585-100, Fax: <44> (1628) 585-900
Renesas Technology (Shanghai) Co., Ltd.
Unit 204, 205, AZIACenter, No. 1233 Lujiazui Ring Rd, Pudong District, Shanghai, China 200120
Tel: <86> (21) 5877-1818, Fax: <86> (21) 6887-7898

## Renesas Technology Hong Kong Ltd.

7th Floor, North Tower, World Finance Centre, Harbour City, 1 Canton Road, Tsimshatsui, Kowloon, Hong Kong
Tel: <852> 2265-6688, Fax: <852> 2730-6071

## Renesas Technology Taiwan Co., Ltd.

10th Floor, No.99, Fushing North Road, Taipei, Taiwan
Tel: <886> (2) 2715-2888, Fax: <886> (2) 2713-2999
Renesas Technology Singapore Pte. Ltd.
1 Harbour Front Avenue, \#06-10, Keppel Bay Tower, Singapore 098632
Tel: <65> 6213-0200, Fax: <65> 6278-8001

## Renesas Technology Korea Co., Ltd.

Kukje Center Bldg. 18th FI., 191, 2-ka, Hangang-ro, Yongsan-ku, Seoul 140-702, Korea
Tel: <82> (2) 796-3115, Fax: <82> (2) 796-2145
Renesas Technology Malaysia Sdn. Bhd
Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No.18, Jalan Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia Tel: <603> 7955-9390, Fax: <603> 7955-9510

